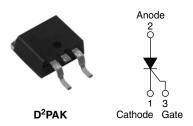




Vishay High Power Products

Surface Mountable Phase Control SCR, 16 A



PRODUCT SUMMARY		
V _T at 16 A	< 1.25 V	
I _{TSM}	300 A	
V_{RRM}	800 to 1600 V	

DESCRIPTION/FEATURES

The 25TTS...S High Voltage Series of silicon controlled rectifiers are specifically designed for medium power switching and phase control applications. The glass passivation technology used has reliable operation up to 125 °C junction temperature.

Typical applications are in input rectification (soft start) and these products are designed to be used with Vishay HPP input diodes, switches and output rectifiers which are available in identical package outlines.

This product has been designed and qualified for industrial level.

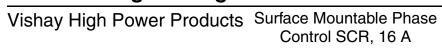
OUTPUT CURRENT IN TYPICAL APPLICATIONS					
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNITS					
NEMA FR-4 or G10 glass fabric-based epoxy with 4 oz. (140 μm) copper	3.5	5.5			
Aluminum IMS, R _{thCA} = 15 °C/W	8.5	13.5	A		
Aluminum IMS with heatsink, R _{thCA} = 5 °C/W	16.5	25.0			

Note

• $T_A = 55$ °C, $T_J = 125$ °C, footprint 300 mm²

MAJOR RATINGS AND CHARACTERISTICS				
PARAMETER	TEST CONDITIONS	VALUES	UNITS	
I _{T(AV)}	Sinusoidal waveform	16	A	
I _{RMS}		25	7	
V _{RRM} /V _{DRM}		800 to 1600	V	
I _{TSM}		300	A	
V _T	16 A, T _J = 25 °C	1.25	V	
dV/dt		500	V/µs	
dI/dt		150	A/μs	
TJ		- 40 to 125	°C	

VOLTAGE RATINGS						
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{DRM} , MAXIMUM PEAK DIRECT VOLTAGE V	I _{RRM} /I _{DRM} , AT 125 °C mA			
25TTS08S	800	800				
25TTS12S	1200	10				
25TTS16S	1600	1600				





ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL TEST CONDITIONS		VALUES			
PARAMETER			CONDITIONS	TYP.	MAX.	UNITS
Maximum average on-state current	I _{T(AV)}	T _C = 93 °C, 180° cond	uction half sine wave	1	6	
Maximum RMS on-state current	I _{RMS}			2	25	Α
Maximum peak, one-cycle,	_	10 ms sine pulse, rated	d V _{RRM} applied	3	00	A
non-repetitive surge current	I _{TSM}	10 ms sine pulse, no v	oltage reapplied	3	50	
Marian III for fraince	l ² t	10 ms sine pulse, rated	d V _{RRM} applied	450		• 2
Maximum I ² t for fusing	I - t	10 ms sine pulse, no v	oltage reapplied	6	30	A ² s
Maximum I $^2\sqrt{t}$ for fusing	I²√t	t = 0.1 to 10 ms, no voltage reapplied		63	300	A²√s
Maximum on-state voltage drop	V_{TM}	16 A, T _J = 25 °C		1.	25	٧
On-state slope resistance	r _t	T 405 00		12	2.0	mΩ
Threshold voltage	V _{T(TO)}	- T _J = 125 °C		1	.0	٧
Marian and discrete and a		T _J = 25 °C	V Datady M	0	.5	
Maximum reverse and direct leakage current	I _{RM} /I _{DM}	$V_R = Rated V_{RRM}/V_{DRM}$		1	0	
Halding a summer	I _H	25TTS08, 25TTS12	Anode supply = 6 V,	-	100	mA
Holding current		25TTS16	resistive load, initial $I_T = 1 A$	100	150	
Maximum latching current	ΙL	Anode supply = 6 V, resistive load		2	00	
Maximum rate of rise of off-state voltage	dV/dt			5	00	V/µs
Maximum rate of rise of turned-on current	dl/dt			1:	50	A/μs

TRIGGERING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum peak gate power	P_{GM}		8.0	W	
Maximum average gate power	P _{G(AV)}		2.0		
Maximum peak positive gate current	+ I _{GM}		1.5	Α	
Maximum peak negative gate voltage	- V _{GM}		10	V	
Maximum required DC gate current to trigger	I _{GT}	Anode supply = 6 V, resistive load, T _J = - 10 °C	60	mA	
		Anode supply = 6 V, resistive load, T _J = 25 °C	45		
		Anode supply = 6 V, resistive load, T _J = 125 °C	20		
		Anode supply = 6 V, resistive load, T _J = - 10 °C	2.5		
Maximum required DC gate voltage to trigger	V_{GT}	Anode supply = 6 V, resistive load, T _J = 25 °C	2.0	V	
		Anode supply = 6 V, resistive load, T _J = 125 °C	1.0	V	
Maximum DC gate voltage not to trigger	V_{GD}	$T_{J} = 125 \text{ °C}, V_{DRM} = \text{Rated value}$ 0.25 2.0			
Maximum DC gate current not to trigger	I _{GD}			mA	

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Typical turn-on time	t _{gt}	T _J = 25 °C	0.9	
Typical reverse recovery time	t _{rr}	T 105 °C	4	μs
Typical turn-off time	tq	T _J = 125 °C	110	



Surface Mountable Phase Vishay High Power Products Control SCR, 16 A

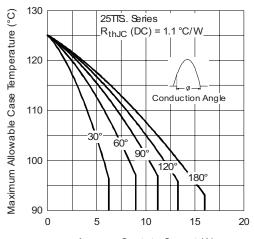
THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range	T _J , T _{Stg}		- 40 to 125	°C	
Soldering temperature	T _S	For 10 s (1.6 mm from case)	240		
Maximum thermal resistance, junction to case	R _{thJC}	R _{thJC} DC operation		°C/W	
Typical thermal resistance, junction to ambient (PCB mount)	R _{thJA} (1)		40	0/11	
Approximate weight			2	g	
Approximate weight			0.07	OZ.	
			25TTS0)8S	
Marking device		Case style D ² PAK (SMD-220)	25TTS1	2S	
			25TTS1	6S	

Note

 $^{^{(1)}}$ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 $\mu m]$ copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994

Vishay High Power Products Surface Mountable Phase Control SCR, 16 A





Average On-state Current (A) Fig. 1 - Current Rating Characteristics

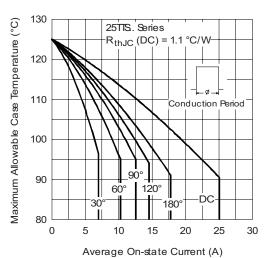


Fig. 2 - Current Rating Characteristics

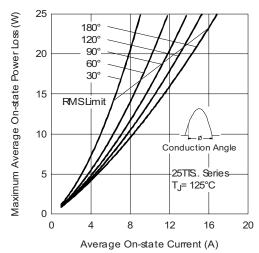


Fig. 3 - On-State Power Loss Characteristics

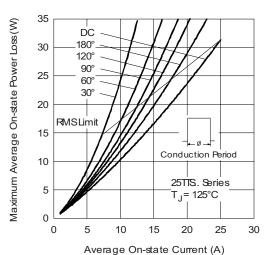


Fig. 4 - On-State Power Loss Characteristics

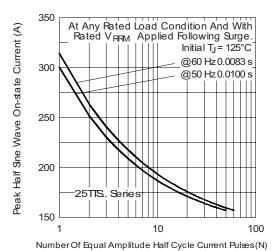


Fig. 5 - Maximum Non-Repetitive Surge Current

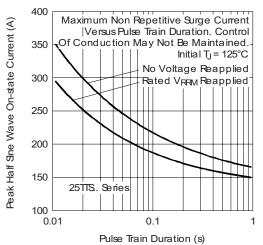


Fig. 6 - Maximum Non-Repetitive Surge Current



Surface Mountable Phase Vishay High Power Products Control SCR, 16 A

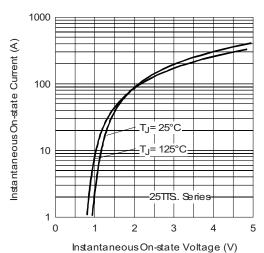
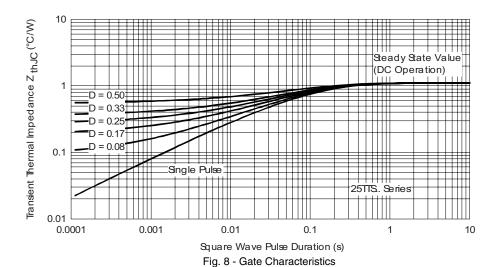


Fig. 7 - On-State Voltage Drop Characteristics



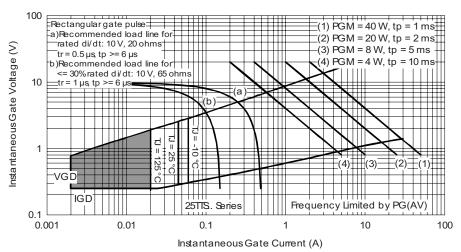
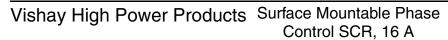
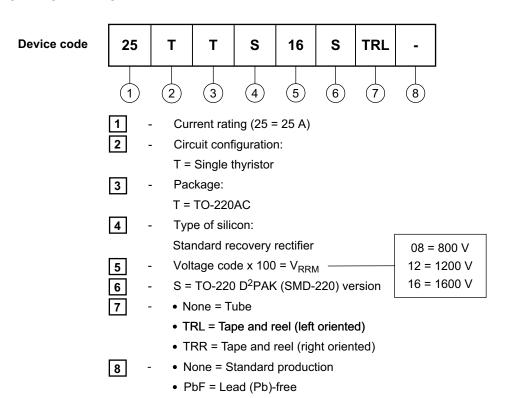


Fig. 9 - Thermal Impedance Z_{thJC} Characteristics





ORDERING INFORMATION TABLE



LINKS TO RELATED DOCUMENTS			
Dimensions http://www.vishay.com/doc?95046			
Part marking information	http://www.vishay.com/doc?95054		
Packaging information http://www.vishay.com/doc?95032			



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Revision: 18-Jul-08

Document Number: 91000 www.vishay.com